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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

·XE

Product Status	Not For New Designs
Core Processor	M16C/60
Core Size	16-Bit
Speed	20MHz
Connectivity	I ² C, IEBus, SIO, UART/USART
Peripherals	DMA, PWM, Voltage Detect, WDT
Number of I/O	39
Program Memory Size	48KB (48K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/m30260f6agp-u7a

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RENESAS

M16C/26A Group (M16C/26A, M16C/26B, M16C/26T) SINGLE-CHIP 16-BIT CMOS MICROCOMPUTER

REJ03B0071-0051 Rev.0.51 Jul.25, 2006

1. Overview

The M16C/26A Group (M16C/26A, M16C/26B, M16C/26T) is a single-chip control MCU, fabricated using high-performance silicon gate CMOS technology, embedding the M16C/60 Series CPU core. The M16C/26A Group (M16C/26A, M16C/26B, M16C/26T) is housed in 42-pin and 48-pin plastic molded packages. With a 1M byte address space, this MCU combines advanced instruction manipulation capabilities to process complex instructions by less bytes and execute instructions at higher speed. The M16C/26A Group (M16C/26B, M16C/26T) has a multiplier and DMAC adequate for office automation, communication devices and industrial equipment, and other high-speed processing applications.

1.1 Applications

Audio, cameras, office/communications/portable/ equipment, air-conditioning equipment, home appliances, etc.



1.2 Performance Outline

Table 1.1 and **1.2** outline performance overview of the M16C/26A Group (M16C/26A, M16C/26B, M16C/26T).

	Item	Specification				
CPU	Basic instructions	91 instructions				
	Minimun instruction	41.7 ns (f(BCLK) = 24MHz ⁽⁴⁾ , Vcc = 4.2 to 5.5 V) (M16C/26B)				
	execution time	50 ns (f(BCLK) = 20MHz, Vcc = 3.0 to 5.5 V) (M16C/26A, M16C/26B, M16C/26T(T-ver.))				
		100 ns (f(BCLK) = 10MHz, Vcc = 2.7 to 5.5 V) (M16C/26A , M16C/26B)				
		50 ns (f(BCLK) = 20MHz, Vcc = 4.2 to 5.5 V -40 to 105°C) (M16C/26T(V-ver.))				
		62.5 ns (f(BCLK) = 16MHz, Vcc = 4.2 to 5.5 V -40 to 125°C) (M16C/26T(V-ver.))				
	Operating mode	Single-chip mode				
	Address space	1 Mbyte				
	Memory capacity	See 1.4 Product Information				
Peripheral	I/O ports	39 I/O pins				
Function	Multifunction timers	TimerA:16 bits x 5 channels, TimerB:16 bits x 3 channels				
		Three-phase motor control timer				
	Serial I/O	2 channels (UART, clock synchronous serial I/O)				
		1 channel (UART, clock synchronous, I ² C bus ⁽¹⁾ , or IEBus ⁽²⁾)				
	A/D converter	10 bit A/D Converter : 1 circuit, 12 channels				
	DMAC	2 channels				
	CRC calcuration circuit	1 circuit (CRC-CCITT and CRC-16) with MSB/LSB selectable				
	Watchdog timer	15 bits x 1 channel (with prescaler)				
	Interrupts	20 internal and 8 external sources, 4 software sources,				
		Interrupt priority level: 7				
(Clock generation circuit	4 circuits				
	Main clock oscillation circuit(*), Sub-clock oscillation circuit(*)					
		On-chip oscillator, PLL frequency synthesizer				
		(*)Equipped with a built-in feedback resister.				
	Oscillation stop detection	Main clock oscillation stop, re-oscillation detection function				
	Voltage detection circuit	On-chip (M16C/26A, M16C/26B), not on-chip (M16C/26T)				
Electrical	Power supply voltage	Vcc = 4.2 to 5.5 V (f(BCLK) = 24 MHz) ⁽⁴⁾ (M16C/26B)				
Characteristics		$V_{CC} = 3.0 \text{ to } 5.5 \text{ V} (f(BCLK) = 20 \text{ MHz})$ (M16C/26A, M16C/26B)				
Characteristics		$V_{CC} = 2.7 \text{ to } 5.5 \text{ V} (f(BCLK) = 10 \text{ MHz})$				
		Vcc = 3.0 to 5.5 V ((M16C/26T(T-ver.))				
		Vcc = 4.2 to 5.5 V (M16C/26T(V-ver.))				
	Power consumption	16 mA (Vcc = 5 V, f(BCLK) = 20 MHz)				
	r ower consumption	$25 \mu\text{A}$ (f(XCIN) = 32 KHz on RAM)				
		$3 \mu\text{A} (\text{Vcc} = 3 \text{V}, \text{f}(\text{XCIN}) = 32 \text{KHz}, \text{ in wait mode})$				
		$3 \mu\text{A} (\text{Vcc} = 3 \text{V}, \text{(ACIN)} = 32 \text{KH2}, \text{ in wait mode})$ 0.7 $\mu\text{A} (\text{Vcc} = 3 \text{V}, \text{ in stop mode})$				
Flach Mamony	Brogramming (araquira	2.7 to 5.5 V (M16C/26A, M16C/26B)				
Flash Memory	Programming /erasure					
Version	voltage	3.0 to 5.5 V (M16C/26T(T-ver.)) 4.2 to 5.5 V (M16C/26T(V-ver.))				
	Programming /erasure	100 times (all area) or 1,000 times (block 0 to 3) (10,000 times (block A , block $B^{(3)}$)				
	endurance	/ 10,000 times (block A, block B) ⁽³⁾				
Operating Amb	ent Temperature	-20 to 85°C / -40 to 85°C ⁽³⁾ (M16C/26A , M16C/26B)				
		-40 to 85°C (M16C/26T(T-ver.))				
		-40 to 105°C / -40 to 125°C (M16C/26T(V-ver.))				
Package		48-pin plastic molded QFP				

Table 1.1	M16C/26A Group(M16C/26A	MIECIZER MIECIZET) Porformanco (18-Din Dackado)
	W100/20A G1000(W100/20A) Feriorinance (40-FIII Fackage)

NOTES:

1. I²C bus is a trademark of Koninklijke Philips Electronics N. V.

2. IEBus is a trademark of NEC Electronics Corporation.

- 3. See Table 1.7 Product Code for the program and erase endurance, and operating ambient temperature.
- 4. The PLL frequency synthesizer is used to run the M16C/26B at f(BCLK) = 24 MHz.

execution time 50 ns (f(BCLK) = 20 MHz, Vcc = 3.0 to 5.5 V) (M16C/26A	(M16C/26B) , M16C/26B) , M16C/26B)		
execution time50 ns (f(BCLK) = 20 MHz, Vcc = 3.0 to 5.5 V) 100 ns (f(BCLK) = 10 MHz, Vcc = 2.7 to 5.5 V)(M16C/26A (M16C/26A)Operation modeSingle-chip modeAddress space1M byte	, M16C/26B)		
100 ns (f(BCLK) = 10 MHz, Vcc = 2.7 to 5.5 V)(M16C/26AOperation modeSingle-chip modeAddress space1M byte			
Operation mode Single-chip mode Address space 1M byte	, M16C/26B)		
Address space 1M byte			
Memory capacity See 1.4 Product Information			
Peripheral Port 33 I/O pins			
function Multifunction timer Timer A: 16 bits x 5 channels, Timer B: 16 bits x 3 channel	ls		
Three-phase motor control timer			
Serial I/O 1 channel (UART, clock synchronous serial I/O)			
1 channel (UART, clock synchronous, I ² C bus ⁽¹⁾ , or IEBus	s ⁽²⁾)		
A/D converter 10 bit A/D converter: 1 circuit, 10 channels			
DMAC 2 channels			
CRC calcuration circuit 1 circuits (CRC-CCITT and CRC-16) with MSB/LSB select	able		
Watchdog timer 15 bits x 1 channel (with prescaler)			
Interrupt 18 internal and 8 external sources, 4 software sources,			
Interrupt priority level: 7			
Clock generation circuit 4 circuits			
Main clock(*), Sub-clock(*)			
On-chip oscillator, PLL frequency synthesizer			
(*)Equipped with a built-in feedback resister.			
Oscillation stop detection Main clock oscillation stop, re-oscillation detection function	1		
Voltage detection circuit On-chip			
Electrical Supply voltage $VCC = 4.2 \text{ to } 5.5 \text{ V} (f(BCLK) = 24 \text{ MHz})^{(4)}$ (N	M16C/26B)		
Characteristics Vcc = 3.0 to 5.5 V (f(BCLK) = 20 MHz) (M16C/26A, M	M16C/26B)		
Vcc = 2.7 to 5.5 V (f(BCLK) = 10 MHz)			
Power Consumption 16 mA (Vcc = 5 V, f(BCLK) = 20 MHz)			
25 μA (f(XCIN) = 32 KHz on RAM)			
$3 \mu A (Vcc = 3 V, f(XCIN) = 32 KHz, in wait mode)$			
$0.7 \ \mu A \ (Vcc = 3 \ V, \text{ in stop mode})$			
Flash memory Programming/erasure 2.7 to 5.5 V			
voltage			
Programming/erasure 100 times (all area) or 1,000 times (block 0 to 3)			
endurance / 10,000 times (block A, block B) ⁽³⁾			
Operating Ambient Temperature -20 to 85°C / -40 to 85°C ⁽³⁾			
Package 42-pin plastic molded SSOP			

Table 1.2. Performance outline of M16C/26A group (M16C/26A, M16C/26B) (42-pin device)

NOTES:

1. I^2C bus is a trademark of Koninklijke Philips Electronics N. V.

2. IEBus is a trademark of NEC Electronics Corporation.

3. See Table 1.7 Product Code for the program and erase endurance, and operating ambient temperature.

4. The PLL frequency synthesizer is used to run the M16C/26B at f(BCLK) = 24 MHz.

1.3 Block Diagram

Figure 1.1 and 1.2 show block diagrams of the M16C/26A Group (M16C/26A, M16C/26B, M16C/26T) 48pin package and 42-pin package.

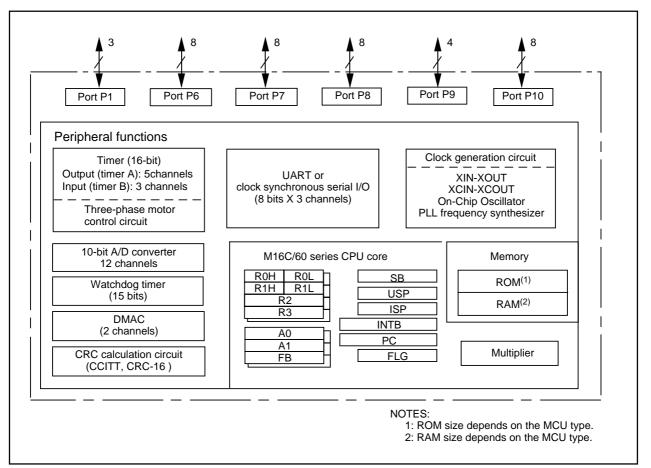


Figure 1.1 Block Diagram(48-pin Package)



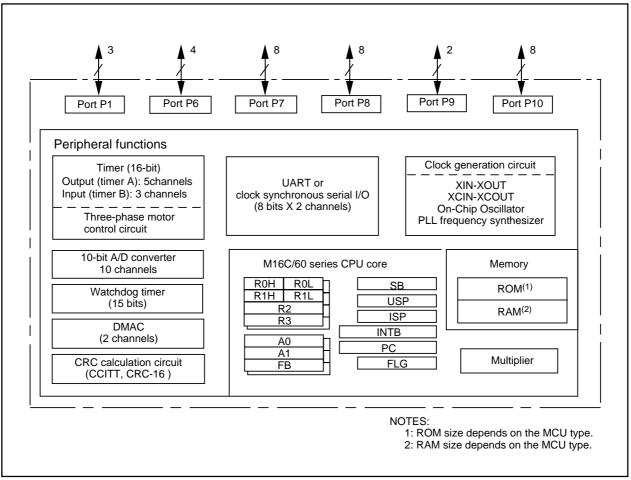


Figure 1.2 Block Diagram(42-pin Package)



Product		Internal ROM (User Program Space)		Internal ROM (Data Space)		Operating Ambient
Code	Package	Program and Erase Endurance	Temperature Range	Program and Erase Endurance	Temperature Range	Temperature
U3		100	0 to 60℃	100	0 to 60℃	-40 to 85⁰C
U5	Lead free	100		100		-20 to 85⁰C
U7	Lead liee	1,000		10,000	-40 to 85℃	-40 to 85⁰C
U9		1,000		10,000	-20 to 85℃	-20 to 85℃

Table 1.7 Product Code (Flash Memory Version) - M16C/26A, M16C/26B

Table 1.8 Product Code (Mask ROM Version - M16C/26A)

Product Code	Package	Operating Ambient Temperature
U3	Lead free	-40℃ to 85℃
U5	Leau nee	-20℃ to 85℃

NOTE:

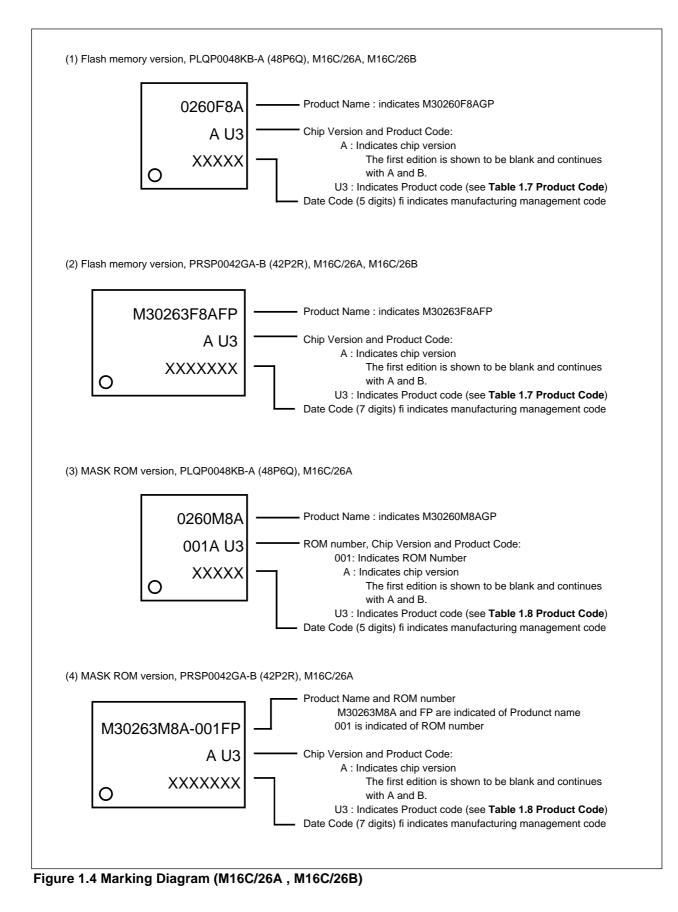
1. The lead contained products, D3, D5, D7, and D9 are put together with U3, U5, U7, and U9 respectively. Lead-free products can be mounted by both conventional Sn-Pb paste and Lead-free paste (Sn-Ag-Cu plating).

Table 1.9 Product Code (Flash Memory Version) - M16C/26T T-ver.

Product		Internal ROM (User Program Space)		Internal ROM (Data Space)		Operating Ambient	
Code	Package	Programming and erasure endurance		Programming and erasure endurance	Temperature range	Temerature	
U3	Lead free	100	0℃ to 60℃	100	-40℃ to 85℃	-40℃ to 85℃	
U7	Leau liee	1,000		10,000		-40.0 10 80.0	

Table 1.10 Product Code (Flash Memory Version) - M16C/26T V-ver.

Product		Internal ROM (User Program Space)		Internal ROM (Data Space)		Operating Ambient	
Code	Package	Programming and erasure endurance	Temperature range	Programming and erasure endurance	Temperature range	Temerature	
U3	Lead free	100	0℃ to 60℃	100	-40℃ to 125℃	-40℃ to 125℃	
U7	Lead liee	1,000		10,000		-40.0 10 125.0	



1.5 Pin Assignments

Figures 1.6 and 1.7 show the Pin Assignments (top view).

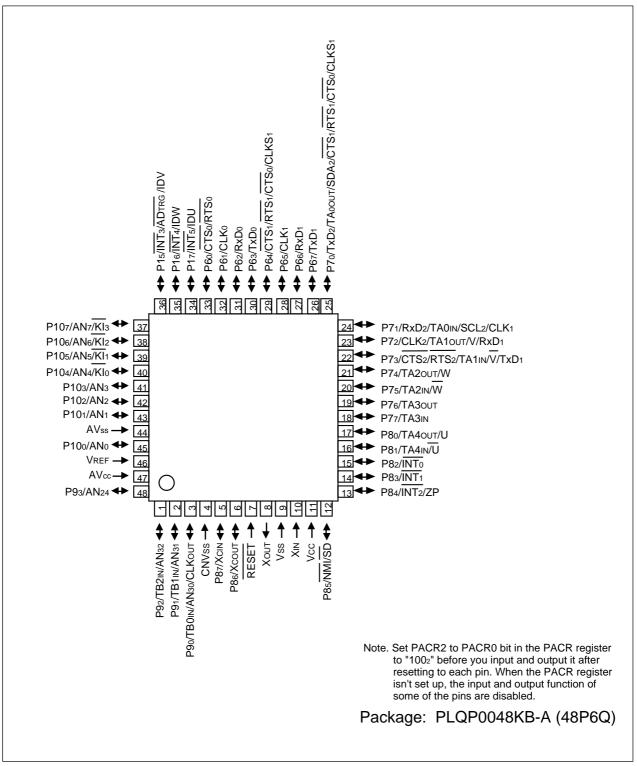


Figure 1.6 Pin Assignment for 48-Pin Package (Top View)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART Pin	Analog Pi
1		P92		TB2IN		AN32
2		P91		TB1IN		AN31
3		P90		ΤΒοιΝ	CLKout	AN30
4	CNVss					
5	XCIN	P87				
6	Хсоит	P86				
7	RESET					
8	Хоит					
9	Vss					
10	Xin					
11	Vcc					
12		P85	NMI	SD		
13		P84	ĪNT2	ZP		
14		P83	INT ₁			
15		P82	INT ₀			
16		P81		TA4IN / Ū		
17		P80		TA40UT / U		
18		P77		ΤΑ3ΙΝ		
19		P76		ТАзоит		
20		P75		TA2IN / W		
21		P74		ТА20UT / W		
22		P73		TA1IN / V	CTS2 / RTS2 / TxD1	
23		P72		TA10UT / V	CLK2 / RxD1	
24		P71		TAOIN	RxD2 / SCL2 / CLK1	
25		P70		ΤΑιουτ	TxD2 / SDA2 / RTS1 / CTS1 / CTS0 / CLKS1	
26		P67			TxD1	
27		P66			RxD1	
28		P65			CLK1	
29		P64			RTS1 / CTS1/ CTS0 / CLKS1	
30		P63				
31		P62			RxDo	
32		P61			CLK0	
33		P60			RTS0 / CTS0	
34		P17	INT ₅	IDU		
35		P16	INT4	IDW		
36		P15	INT3	IDV		ADTRG
37		P107	Kl3			AN7
38		P106	Kl2			AN6
39		P105	KI1			AN5
40		P104	KIO			AN4
41		P103				AN3
42		P102				AN2
43		P101				AN1
44	AVss					
45		P100				ANo
46	Vref					
47	AVcc					
48		P93				AN24

Table 1.11 Pin Characteristics for 48-Pin Package



Pin No.	Control Pin	Port	Interrupt Pin		UART Pin	Analog Pin
1	AVss					
2		P100				ANo
3	Vref					
4	AVcc					
5		P91		TB1IN		AN31
6		P90		ΤΒοιΝ	CLKout	AN30
7	CNVss					
8	XCIN	P87				
9	Хсоит	P86				
10	RESET					
11	Хоит					
12	Vss					
13	Xin					
14	Vcc					
15		P85	NMI	SD		
16		P84	ĪNT2	ZP		
17		P83	INT ₁			
18		P82	INT ₀			
19		P81		TA4IN / Ū		
20		P80		ТА40UT / U		
21		P77		ТАзіл		
22		P76		ТАзоит		
23		P75		TA2IN / W		
24		P74		ТА20UT / W		
25		P73		TA1IN / V	CTS2 / RTS2 / TxD1	
26		P72		TA10UT / V	CLK2 / RxD1	
27		P71		TAOIN	RxD2 / SCL2 / CLK1	
28		P70		ΤΑοουτ	TxD2 / SDA2 / RTS1 / CTS1 / CTS0 / CLKS1	
29		P67			TxD1	
30		P66			RxD1	
31		P65			CLK1	
32		P64			RTS1 / CTS1/ CTS0 / CLKS1	
33		P17	INT5	IDU		
34		P16	INT4	IDW		
35		P15	INT3	IDV		ADTRG
36		P107	KI3			AN7
37		P106	KI2			AN6
38		P105	KI1			AN5
39		P104	KIO			AN4
40		P103				AN3
41		P102				AN2
42		P101				AN1

Table 1.12 Pin Characteristics for 42-Pin Package



Classification	Pin Name	I/O Type	Description	
Serial I/O	CTS0	I	Inputs pin to control data transmission	
	RTS0	0	Output pin to control data reception	
	CLK0	I/O	Inputs and outputs the transfer clock	
	RxD0	I	Inputs serial data	
	TxD0	0	Outputs serial data	
Timer B	TB2IN	I	Timer B2 input pin	
A/D Converter	AN24	I	Analog input pins for the A/D converter	
	AN32			
I/O Ports	P60 to P63	I/O	I/O ports for CMOS. Each port can be programmed for input or output	
	P92 to P93		under the control of the direction register. An input port can be set, by	
			program, for a pull-up resistor available or for no pull-up resister available	
			in 4-bit units	
I : Input O :	Output	I/O : Input	and output	

Table 1.13 Pin	Description ((48-pin packages	only) (Continued)
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2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU registers. The register bank is comprised of seven registers (R0, R1, R2, R3, A0, A1 and FB) out of 13 registers. There are two sets of register bank.

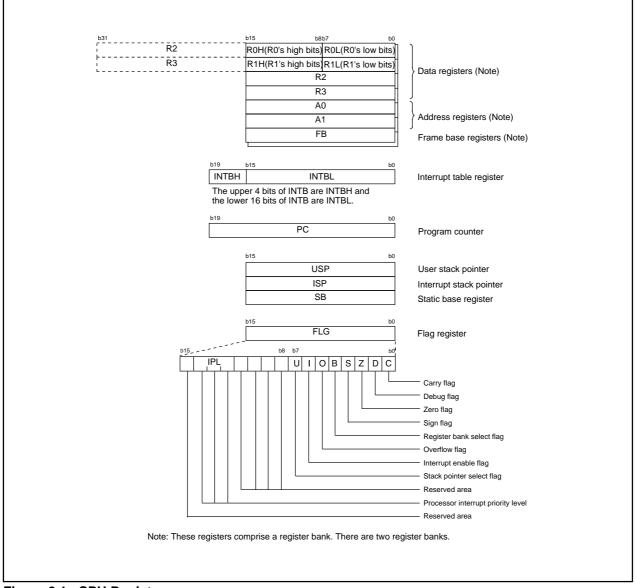


Figure 2.1. CPU Register

2.1 Data Registers (R0, R1, R2 and R3)

The R0 register consists of 16 bits, and is used mainly for transfers and arithmetic/logic operations. R1 to R3 are the same as R0.

The R0 register can be separated between high (R0H) and low (R0L) for use as two 8-bit data registers. R1H and R1L are the same as R0H and R0L. Conversely, R2 and R0 can be combined for use as a 32-bit data register (R2R0). R3R1 is the same as R2R0.

2.2 Address Registers (A0 and A1)

The register A0 consists of 16 bits, and is used for address register indirect addressing and address register relative addressing. They also are used for transfers and arithmetic/logic operations. A1 is the same as A0.

In some instructions, registers A1 and A0 can be combined for use as a 32-bit address register (A1A0).



4. Special Function Register (SFR)

Table 4.1 SFR Information(1)⁽¹⁾

Address	Register	Symbol	After reset	
000016				
000116				
000216				
000316				
000416	Processor mode register 0	PM0	0016	
000516	Processor mode register 0	PM1	000010002	
000616	System clock control register 0	CM0	010010002(M16C/26A)	
000010		Civic	011010002(M16C/26T)	
000716	System clock control register 1	CM1	001000002	
000718			001000002	
000916	Address match interrupt enable register	AIER XXXXX002		
000918 000A16	Protect register	PRCR	XX0000002	
000A16		FROM	X0000002	
000B16	Oscillation stop detection register ⁽²⁾	CM2	0X000002	
000C16		CIVIZ	0X0000002	
	Watch dog timor atort register	WDTC	XX40	
000E16	Watchdog timer start register	WDTS	XX16	
000F16	Watchdog timer control register	WDC	00XXXXX2 ⁽³⁾	
001016	Address match interrupt register 0	RMAD0	0016	
001116			0016	
001216			X016	
001316			00.10	
001416	Address match interrupt register 1	RMAD1	0016	
001516			0016	
001616			X016	
001716				
001816				
001916	Voltage detection register 1 (4, 5)	VCR1	000010002	
001A16	Voltage detection register 2 (4, 5)	VCR2	0016	
001B16				
001C16	PLL control register 0	PLC0	0001X0102	
001D16				
001E16	Processor mode register 2	PM2	XXX000002	
001F16	Low voltage detection interrupt register ⁽⁵⁾	D4INT	0016	
002016	DMA0 source pointer	SAR0	XX16	
002116			XX16	
002216			XX16	
002316				
002416	DMA0 destination pointer	DAR0	XX16	
002516			XX16	
002616			XX16	
002716				
002816	DMA0 transfer counter	TCR0	XX16	
002916			XX16	
002A16				
002B16				
002C16	DMA0 control register	DM0CON	00000X002	
002D16	V			
002E16				
002F16				
003016	DMA1 source pointer	SAR1	XX16	
003116			XX16	
003216			XX16	
003216				
003416	DMA1 destination pointer	DAR1	XX16	
003418			XX16	
003616			XX16	
003016				
	DMA1 transfer counter	TCR1	XX16	
003010			XX16	
003816				
003916				
003916 003A16				
003916 003A16 003B16	DMA1 control register		00000X002	
003916 003A16 003B16 003C16	DMA1 control register	DM1CON	00000X002	
003916 003A16 003B16 003C16 003D16	DMA1 control register	DM1CON	00000X002	
003916 003A16 003B16 003C16	DMA1 control register	DM1CON	00000X002	

NOTES:

The blank spaces are reserved. No access is allowed.
 Bits CM27, CM21, and CM20 do not change at oscillation stop detection reset.

The WDC5 bit is 0 (cold start) immediately after power-on. It can only be set to 1 by program. The WDC5 bit cannot be used in M16C/26T.

4. The VCR1 and VCR2 registers do not change at software reset, watchdog timer reset, and oscillation stop detection reset.

5. Registers VCR1, VCR2, and D4INT cannot be used in M16C/26T.

X : Undefined



Table 4.2 SFR Information(2)⁽¹⁾

Address	Register	Symbol	After reset
004016 004116			
004116			
004216			
004316	INT3 interrupt control register	INT3IC	XX00X0002
004516			77700770002
004616			
004716			
004816	INT5 interrupt control register	INT5IC	XX00X0002
004916	INT4 interrupt control register	INT4IC	XX00X0002
004A16	UART2 Bus collision detection interrupt control register	BCNIC	XXXXX0002
004B16	DMA0 interrupt control register	DM0IC	XXXXX0002
004C16	DMA1 interrupt control register	DM1IC	XXXXX0002
004D16	Key input interrupt control register	KUPIC	XXXXX0002
004E16	A/D conversion interrupt control register	ADIC	XXXXX0002
004F16	UART2 transmit interrupt control register	S2TIC	XXXXX0002
005016	UART2 receive interrupt control register	S2RIC	XXXXX0002
005116	UART0 transmit interrupt control register	SOTIC	XXXXX0002
005216	UART0 receive interrupt control register	SORIC	XXXXX0002
005316	UART1 transmit interrupt control register	S1TIC	XXXXX0002
005416	UART1 receive interrupt control register	S1RIC	XXXXX0002
005516	TimerA0 interrupt control register	TAOIC	XXXXX0002
005616	TimerA1 interrupt control register	TA1IC	XXXXX0002
005716	TimerA2 interrupt control register	TA2IC	XXXXX0002
005816	TimerA3 interrupt control register	TA3IC	XXXXX0002
005916	TimerA4 interrupt control register TimerB0 interrupt control register	TA4IC	XXXXX0002
005A16 005B16	TimerB0 Interrupt control register	TB0IC TB1IC	XXXXX0002 XXXXX0002
005D16	TimerB2 interrupt control register	TB2IC	XXXXX0002
005D16	INTO interrupt control register	INTOIC	XX00X0002
005E16	INT1 interrupt control register	INT0IC	XX00X0002 XX00X0002
005F16	INT2 interrupt control register	INT2IC	XX00X0002
006016			70100710002
006116			
006216			
006316			
006416			
006516			
006616			
006716			
006816			
006916			
006A16			
006B16			
006C16			
006D16			
006E16			
006F16			
007016			
007116			
007216			
007316			
007416			
007516			
007616			
007716 007816			
007816			
007916 007A16			
007A16			
007B16 007C16			
007C16			
007E16			
007E16			
		I	1

NOTE:

1. Blank spaces are reserved. No access is allowed. X: Undefined

Table 4.4 SFR Information(4)⁽¹⁾

Address	Register	Symbol	After reset		
034016					
034116					
034216 034316	Timer A1-1 register	TA11	XX16 XX16		
034416 034516	Timer A2-1 register	TA21	XX16 XX16		
034616 034716	Timer A4-1 register	TA41	XX16 XX16		
034816	Three phase PWM control register 0	INVC0	0016		
034916	Three phase PWM control register 1	INVC1 0016			
034A16	Three phase output buffer register 0	IDB0 3F16			
034B16	Three phase output buffer register 1	IDB1 3F16			
034C16	Dead time timer	DTT XX16			
034D16	Timer B2 Interrupt occurrence frequency set counter	ICTB2 XX16			
034E16	Position-data-retain function control register	PDRF	XXXX00002		
034F16					
035016					
035116					
035216					
035316					
035416 035516					
035516					
035716					
035816	Port function control register	PFCR	001111112		
035916		FIGN	00111112		
035A16					
035B16					
035C16					
035D16					
035E16	Interrupt request cause select register 2	IFSR2A	XXXXXXX02		
035F16	Interrupt request cause select register	IFSR	0016		
036016					
036116					
036216					
036316					
036416					
036516					
036616					
036716					
036816 036916					
036916 036A16					
036B16					
036C16					
036D16					
036E16					
036F16					
037016					
037116					
037216					
037316					
037416	UART2 special mode register 4	U2SMR4	0016		
037516	UART2 special mode register 3	U2SMR3	000X0X0X2		
037616			X0000002		
037716			X0000002		
037816	UART2 transmit/receive mode register	U2MR 0016			
037916 037A16	UART2 bit rate register U2BRG XX16				
	UART2 transmit buffer register U2TB XXXXXX2				
037B16 037C16	UART2 transmit/receive control register 0	U2C0	XXXXXXXX2 000010002		
037C16 037D16	UART2 transmit/receive control register 0	U2C1	00001002		
037D16	UART2 receive buffer register	U2RB	XXXXXXXX2		
037E16			XXXXXXXXX2		
NOTE:		1			

NOTE: 1. Blank spaces are reserved. No access is allowed. X : Undefined

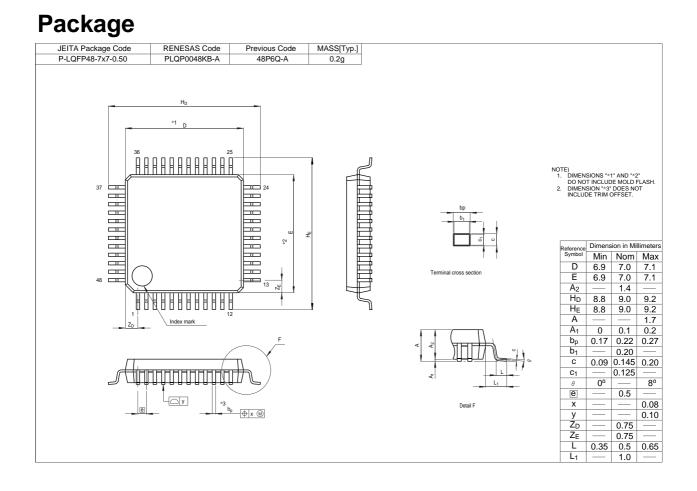
Table 4.5 SFR Information(5)⁽¹⁾

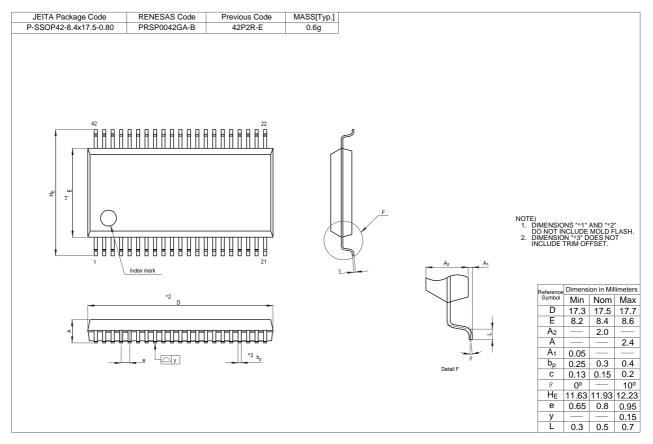
Address	Register	Symbol	After reset	
038016	Count start flag	TABSR 0016		
038116	Clock prescaler reset flag	CPSRF	0XXXXXXX2	
038216	One-shot start flag	ONSF	0016	
038316	Trigger select register	TRGSR	0016	
038416	Up-dowm flag	UDF	0016	
038516				
038616	Timer A0 register	TA0	XX16	
038716	-		XX16	
038816	Timer A1 register	TA1	XX16	
038916			XX16	
038A16	Timer A2 register	TA2	XX16	
038B16			XX16	
038C16	Timer A3 register	TA3	XX16	
038D16			XX16	
038E16	Timer A4 register	TA4	XX16	
038F16			XX16	
039016	Timer B0 register	TB0	XX16	
039116	-		XX16	
039216	Timer B1 register	TB1	XX16	
039316	-		XX16	
039416	Timer B2 register	TB2	XX16	
039516			XX16	
039616	Timer A0 mode register	TAOMR	0016	
039716	Timer A1 mode register	TA1MR	0016	
039816	Timer A2 mode register	TA2MR	0016	
039916	Timer A3 mode register	TA3MR	0016	
039A16	Timer A4 mode register	TA4MR	0016	
039B16	Timer B0 mode register	TBOMR	00XX00002	
039C16	Timer B1 mode register	TB1MR	00XX00002	
039D16	Timer B2 mode register	TB2MR	00XX00002	
039E16	Timer B2 special mode register	TB2SC	X0000002	
039F16		10200	X0000002	
03A016	UART0 transmit/receive mode register	U0MR	0016	
03A116	UARTO bit rate register	U0BRG	XX16	
03A216	UART0 transmit buffer register	U0TB	XXXXXXXXX2	
03A316	OARTO Hansmit Burlet register	0010	XXXXXXXXX2	
03A416	UART0 transmit/receive control register 0	U0C0	000010002	
03A516	UART0 transmit/receive control register 0	U0C1	000000102	
03A616	UARTO receive buffer register	UORB	XXXXXXXX2	
03A716	OAITIO leceive bullet legister	OURD	XXXXXXXXX2	
03A816	LIADT1 transmit/reasily a mode register	U1MR		
03A916	UART1 transmit/receive mode register		<u>0016</u>	
03A316	UART1 bit rate register	U1BRG U1TB	XX16	
03AB16	UART1 transmit buffer register	UIIB	XXXXXXXX2	
03AB16 03AC16		1400	<u> </u>	
		U1C0	000010002	
03AD16 03AE16	UART1 transmit/receive control register 1		U1C1 000000102	
03AE16 03AF16	UART1 receive buffer register	U1RB	XXXXXXXX2	
	LIART transmit/respires control to rists a		XXXXXXXX2	
03B016 03B116	UART transmit/receive control register 2	UCON	X0000002	
03B216				
03B316 03B416		000000	VV	
	CRC snoop address register	CRCSAR	XX16	
03B516			00XXXXX2	
03B616	CRC mode register	CRCMR	0XXXXXX02	
03B716				
03B816	DMA0 request cause select register	DM0SL	0016	
03B916				
03BA16	DMA1 request cause select register	DM1SL	0016	
03BB16				
03BC16	CRC data register	CRCD	XX16	
03BD16			XX16	
03BE16	CRC input register	CRCIN	XX16	
03BF16		1 1		

NOTE:

1. Blank spaces are reserved. No access is allowed.

X : Undefined





REVISION HISTORY

M16C/26A Group (M16C/26A, M16C/26B, M16C/26T) Shortsheet

Rev.	Date		Description
		Page	Summary
0.51	07/25/06	-	First edition
	01,20,00		

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